# SPIE event printed pieces



# **Event overviews**

Distributed onsite to all technical attendees, this piece reaches research and development professionals in different fields with news of your products and services. Most people will keep this piece in hand during the event, providing you with an opportunity to gain visibility.

# **Exhibition guides**

Distributed at the event, this handy guide features exhibitor information and show floor locations. Increase your impact on your primary target audience with an ad in the colorful exhibition guide.



# Reach thousands of potential customers who use SPIE event pieces to plan their agendas

|            |  | _                                 | tial customers who<br>lan their agendas   | EST, ATTE. | ~ NDANCE | EXHIC | W. WILLOW |
|------------|--|-----------------------------------|---|------------|----------|-------|-----------|
|            | URED EVENTS                                  | LOCATION                          | CONFERENCE TOPICS   | £57.       | FVEN     | EXH   | J.,       |
| SPIE.      | PHOTONICS<br>WEST                            |                                   | Photonics West OPTO and LASE • Laser sources • Nonlinear optics and beam guiding • Micro/nano applications • Macro applications • Optoelectronic materials and devices • Photonic integration • Nanotechnologies in photonics • MOEMS-MEMS in photonics • Advanced quantum and optoelectronic applications • Semiconductor lasers and LEDs • Displays and holography • Optical communications: Devices to systems • 3D printing • Sustainability, Al/ML • Quantum   |            | V        | V     | ,         |
| SPIE.      | PHOTONICS WEST BIOS                          | San Francisco,<br>California, USA | <b>BiOS</b> • Photonic therapeutics and diagnostics • Neurophotonics, neurosurgery, and optogenetics • Clinical technologies and systems • Tissue optics, laser-tissue interaction, and tissue engineering • Biomedical spectroscopy, microscopy, and imaging • Nano/biophotonics • BRAIN • Translational research • 3D printing • Net Zero, Al/ML • Quantum Biology  | 20,000     |          |       |           |
| SPIE       | QUANTUM<br>WEST                              |                                   | <b>Quantum West</b> • Quantum information systems • Quantum communications • Quantum computing and simulation • Quantum sensing, imaging, and timing systems • Enabling materials, devices, and techniques • Quantum Biology  |            |          |       |           |
| SPIE.      | ARIVRIMR                                     | San Francisco,<br>California, USA | 3D computer vision/perception • display techniques/technologies/architectures • reconstruction • combiner optics/related architectures • human-machine interactions • human perception/immersive displays • light-field rendering • MEMS mirrors • display engines/imaging systems • optical sensors for 6DOF head tracking/SLAM-relocalization nanophotonics   | 3,000      | ~        |       |           |
| SPIE       | MEDICAL<br>MAGING                            | San Diego,<br>California, USA     | Physics of medical imaging • Image processing • Computer-aided diagnosis • Image-guided procedures, robotic interventions, and modeling • Molecular, structural, and functional imaging • Image perception, and technology assessment • PACS-based imaging informatics • Ultrasonic imaging, tomography, and therapy • Digital pathology  | 1,000      | ~        |       |           |
| SPIE.      | ADVANCED<br>LITHOGRAPHY+<br>PATTERNING       | San Jose,<br>California, USA      | Immersion • DFM/DPI • Nanofabrication and imprint • Resists • Etch • Lithography • Metrology • Inspection • DUV and EUV sources and optics • Process control • Patterning   | 2,000      | ~        | ~     |           |
| ARCH SPIE  | SMART STRUCTURES+ NONDESTRUCTIVE EVALUATION  | Long Beach,<br>California, USA    | Electroactive polymers • Smart structures and materials • Actuators and damping • Biomimetics • Energy harvesting • Embedded sensors • Sensor networks • Real-time NDE • Structural health monitoring • Fiber sensors   | 700        | V        |       |           |
| DIE        | OPTICAL<br>SYSTEMS<br>DESIGN                 | Strasbourg,<br>France             | Optical Design • Thin Films • Fabrication • Testing • Metrology • Illumination • Computational Optics • Instrument Technologies   | 400        | ~        | ~     |           |
| SPIE       | PHOTONICS<br>EUROPE                          | Strasbourg,<br>France             | Biophotonics • Micro/Nano technologies • Metamaterials • Photonic crystal fibers and devices • MEMS/MOEMS • Nanometrology • Optical sensors • Silicon photonics and photonic integrated circuits • Organic photonics • Solid-state lasers • Fiber lasers • Amplifiers • Photovoltaics • Photonics in automobiles • Image processing   | 1,900      | ~        |       |           |
| SPIE.      | FUTURE SENSING TECHNOLOGIES                  | Yokohama,<br>Japan                | Quantum sensing • Cameras and imaging systems • AR/VR • Optical communications • Space-based missions • RADAR systems • Multi-band and hyperspectral imaging • LIDAR technology and applications • Polarization sensing and imaging • EO/IR/SWIR sensing and imaging • UAV applications • Autonomous vehicle sensing • Sensor-based sorting & quality control   | 125        | •        |       |           |
| SPIE.      | DEFENSE+ COMMERCIAL SENSING                  | National Harbor,<br>Maryland, USA | Next generation sensor systems and applications • Advanced sensing and imaging • Imaging and analytics • Materials and devices • Big data • Al/ML • Autonomous systems • AR/VR/ XR • Cyber security • Advanced photon counting • IR Technology  | 3,500      | ~        | V     |           |
| SPIE.      | ASTRONOMICAL TELESCOPES + INSTRUMENTATION    | Yokohama,<br>Japan                | Optical, infrared, and millimeter wave and interferometry • Ultraviolet to gamma ray • Space and ground-based and airborne telescopes and instrumentation • Adaptive optics systems • Observatory operations • Modeling, systems engineering, and project management • Advances in optical and mechanical technologies • Millimeter, submillimeter, and far-infrared detectors and instrumentation • Software and cyberinfrastructure • High-energy, optical, and infrared detectors • Radio telescopes and telescopic arrays | 2,500      | ~        | ~     |           |
| SPIE       | OPTICS+ PHOTONICS                            | San Diego,<br>California, USA     | Advanced metrology • Remote sensing • Optical system design • Illumination engineering • Photovoltaics • Thin film coatings • Illumination systems • Solar concentrators • Plasmonics • Nanoengineered materials • Metamaterials • Nanocoatings • Nanomanufacturing • Organic photonics and electronics • Detectors and imaging • Photonic devices • OLEDs and LEDs • Lasers  | 3,000      | ~        | ~     |           |
| SPIE.      |  | Edinburgh,<br>United Kingdom      | Remote Sensing • Atmospheric sensing • Platforms and systems • Environmental monitoring and applications • Earth surface sensing • Image and signal processing  Security + Defence • Electro-optical sensing • Infrared systems • Optical materials and technologies • Sensors and networks • Millimetre wave and terahertz sensors • Biomaterials  | 900        | ~        | V     |           |
|            | PHOTOMASK<br>TECHNOLOGY +<br>EUV LITHOGRAPHY | Monterey,<br>California, USA      | Photomask • Design automation and data prep • Inverse lithography • Mask writing • Defects • Metrology • Inspection and repair • Maskless processes  EUV Lithography • Sources and optics • Metrology and inspection • Mask and imaging • Pellicles • Resists • Process control and stochastics • Patterning and process enhancement • Extendibility • High-NA EUV  | 500        | V        |       |           |
|            | PHOTONEX                                     | Manchester,<br>United Kingdom     | Quantum technologies • Photonics • Biophotonics • Lasers • Optical technologies • Materials analysis • Nanotechnology and thin film coatings • Vacuum equipment and in-vacuum technologies  | 1000       | V        | ~     |           |
| BD<br>SPIE | LASER<br>DAMAGE                              | TBD                               | Optical materials and measurements • Surfaces, mirrors and contamination • Thin films • Fundamental mechanisms • Laser-induced damage issues • Applications of laser damage • Properties modeling • Testing • Component fabrication   | 155        | V        |       |           |
| SPIE. PHO  | OTONICS<br>A                                 | China                             | High-power lasers • Semiconductor lasers • Optoelectronic devices and integration • Optical design and testing • Holography • Diffractive optics • Biomedical optics • Advanced sensor systems • Nanophotonics and micro/nano-optics • Plasmonics • Quantum and nonlinear optics  | 800        | ~        |       |           |

# SPIE EVENT ADVERTISING

## 2024 insertion order

Contact SPIE Sales:

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### SEE NEXT PAGE FOR:

- MECHANICAL REQUIREMENTS
- ELECTRONIC FILE REQUIREMENTS
- AD SUBMISSION GUIDELINES
- POLICIES

# 1 PLEASE PROVIDE COMPLETE BILLING INFORMATION

| My company is an SPIE Corporate Memb | per 🛮 No 🗖 Yes Corporate ID#                         |  |
|--------------------------------------|--|--|
| Advertising company                  |  |  |
|                                      |  |  |
|                                      | State/Prov Zip                                       |  |
| Contact                              | Title  |  |
| Telephone                            | Fax  |  |
| Email                                | ☐ Bill to <b>advertising company</b> (not ad agency) |  |
| Ad agency                            |  |  |
|                                      |  |  |
|                                      | State/Prov Zip                                       |  |
| Contact                              | Title  |  |
| Telephone                            | Fax  |  |
| Email                                | P.O. (if required for billing)                       |  |

### 2 SELECT ADVERTISEMENT For Photonics West/BiOS, please use corresponding insertion order.

|   | Event overview | Exhibition guide | Event overview/ exhibition guide | Insertion order due |
|---|----------------|------------------|----------------------------------|---------------------|
| SPIE Advanced Lithography + Patterning                          |                |                  |                                  | 8 Jan 2024          |
| SPIE AR   VR   MR   |                |                  |                                  | 27 Nov 2023         |
| SPIE Astronomical Telescopes + Instrumentation                  |                |                  |                                  | 27 Apr 2024         |
| SPIE Defense + Commercial Sensing                               |                |                  |                                  | 3 Mar 2024          |
| SPIE Future Sensing Technologies                                |                |                  |                                  | TBD                 |
| SPIE Laser Damage   |                |                  |                                  | TBD                 |
| SPIE Medical Imaging*   |                |                  |                                  | 5 Jan 2024          |
| SPIE Optical Systems Design                                     |                |                  |                                  | 16 Feb 2024         |
| SPIE Optics + Photonics   |                |                  |                                  | 30 June 2024        |
| SPIE Photomask Technology + EUV Lithography                     |                |                  |                                  | 9 Aug 2024          |
| SPIE Photonex   |                |                  | □A4 size                         | 11 Sept 2024        |
| SPIE Photonics Europe   |                |                  |                                  | 16 Feb 2024         |
| SPIE Sensors + Imaging* (Remote Sensing/Security + Defence)     |                |                  | □A4 size                         | 28 July 2024        |
| SPIE Smart Structures + Nondestructive Evaluation*              |                |                  |                                  | 5 Feb 2024          |
| SPIE/COS Photonics Asia   |                |                  |                                  | TBD                 |
| SPIE Translational Biophotonics                                 |                |                  |                                  | TBD                 |
| *40% discount— Medical Imaging, Sensors + Imaging, Smart Struct | ures + Nondes  | tructive Evaluat | ion                              |                     |

#### **3** SPECIFY ADVERTISEMENT SIZE

 $\hfill\square$  Please send invoice upon receipt of this contract.

| ☐ Technical program or ☐ Exhibition guide or ☐ Combined technical program/exhibition guide (European events) |                 |           |  |  |  |
|--|-----------------|-----------|--|--|--|
| Ad size  | Black and white | 4-color   | Special position 4-color                 |  |  |
| Full page  | □ \$1,268       | □ \$2,548 | Cover 2 (inside front) ☐ \$3,938         |  |  |
| 2/3 Page   | □ \$1,001       | □ \$2,225 | Cover 3 (inside back) 🗆 \$3,738          |  |  |
| 1/2 Page vertical  | □ \$856         | □ \$2,114 | Cover 4 (back cover) □ \$4,093           |  |  |
| 1/2 Page horizontal  | □ \$856         | □ \$2,114 | Page 3 □ \$3,582 Other righthand         |  |  |
| 1/3 Page   | □ \$623         | □ \$1,880 | Page 5 □ \$3,582 forward pages available |  |  |
| 1/4 Page   | □ \$512         | □ \$1,780 | Page 7 □ \$3,582 upon request.           |  |  |

|   | ree to abide by the policies listed. Hand-written signature required.  Title |  |
|---|--|--|
| Authorizing signature                                     |  |  |
| <b>5 PAYMENT INFORMATION</b> Bille                        | ed after publication prints. Please check one of the following options:      |  |
| ☐ Check/money order enclosed (payable                     | le to SPIE)  |  |
| ☐ Credit card  SPIE accepts VISA, MasterCard, American Ex | xpress, Diners Club, and Discover cards                                      |  |
| ☐ Wire transfer   | = \$o you.   |  |

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# SPIE EVENT ADVERTISING

2024 insertion order

#### **MECHANICAL REQUIREMENTS**

TRIM SIZE Program will be cut to this size.

**BLEED SIZE** Background imagery need to be larger than trim so it appears to go off the edge.

**LIVE AREA** Keep all text and important elements inside live area so they do not get cut off when program is bound and trimmed after printing.

#### REMOVE PRINTER MARKS INCLUDING REGISTRATION AND CROP MARKS FROM YOUR AD FILE

# Technical program Exhibition guide

Full page/special position

TRIM:  $8\frac{3}{8} \times 10\frac{3}{4}$  in. = 213 × 273 mm BLEED:  $8\frac{3}{4} \times 11\frac{1}{8}$  in. = 222 × 283 mm

LIVE: 7 × 10 in. = 178 × 254 mm

| Ad size             | Inches                            | Millimeters |
|---------------------|-----------------------------------|-------------|
| 2/3 Page            | $4^{9}/_{16} \times 10$           | 115 × 254   |
| 1/2 Page vertical   | $3^{5}/_{16} \times 10$           | 84 × 254    |
| 1/2 Page horizontal | 7 × 4 <sup>7</sup> / <sub>8</sub> | 178 × 124   |
| 1/3 Page vertical   | $2^{3}/_{16} \times 10$           | 56 × 254    |
| 1/4 Page            | $3^{5}/_{16} \times 4^{7}/_{8}$   | 84 × 124    |

#### **A4 SIZE FOR ALL EUROPEAN EVENTS**

Full page/special position

TRIM:  $8.27 \times 11.69$  in. =  $210 \times 297$  mm BLEED:  $8.77 \times 12.19$  in. =  $223 \times 310$  mm LIVE:  $7.27 \times 10.69$  in. =  $185 \times 272$  mm

| Ad size             | Inches       | Millimeters |  |  |
|---------------------|--------------|-------------|--|--|
| 2/3 Page            | 4.75 × 10.69 | 121 × 272   |  |  |
| 1/2 Page vertical   | 3.5 × 10.69  | 89 × 272    |  |  |
| 1/2 Page horizontal | 7.27 × 5     | 185 × 127   |  |  |
| 1/3 Page vertical   | 2.25 × 10.69 | 57 × 272    |  |  |
| 1/4 Page            | 3.5 × 5      | 89 × 127    |  |  |

#### **ELECTRONIC FILE REQUIREMENTS**

- AD SHOULD BE FURNISHED AS A HIGH-RESOLUTION PDF (at least 300 dpi). Fonts must be embedded, outlined, or included. All colors should be CMYK builds. Note: eps, jpg, and tif files will be accepted but PDF IS PREFERRED.
- Keep essential matter of an ad (text or image) inside the live area or 1/4" inside TRIM.
- PLEASE REMOVE ALL PRINTER MARKS INCLUDING REGISTRATION AND CROP MARKS FROM YOUR AD FILE.

#### **AD MATERIAL SUBMISSION GUIDELINES**

- Ads can be emailed (files <5 MB may be emailed to advertising@spie.org)
- Please contact advertising@spie.org with questions about ad submissions.

#### **POLICIES**

- Changes or modifications to submitted ad materials may be subject to production charges.
- SPIE does not guarantee reproduction quality for late ads or ads that do not meet the mechanical and electronic file requirements.
- Ad materials are stored for 12 months, unless other arrangements have been made in writing.
- No refunds on ads cancelled after insertion order due dates.
- No guaranteed ad placement other than accepted special cover positions.
- SPIE reserves the right to cancel or reject any advertisement; this includes solicitation by organizations for membership and event attendees, authors or exhibitors, or products unrelated to the event.
- · Simulation of the publication's format is not permitted.
- SPIE reserves the right to place the word "advertisement" with copy that, in the publisher's opinion, resembles editorial matter.
- All advertising is subject to publisher's approval and agreement by the advertiser and agency to indemnify and protect the publisher from and against any claims, loss, liability, or expense, including reasonable attorney's fees, arising out of publication of such advertisement.
- Ads received after the materials due dates are subject to a 10% surcharge.
- Recognized ad agencies will receive a 15% commission.
   Commissions given to ad agencies will be forfeited if payment is not received within 60 days of invoice date.
- Account delinquency may affect advertiser's and agency's ability to book space in future issues.
- For accounts with more than one unpaid invoice, all cash received will be paid to oldest invoice first.
- Advertiser and agency agree to pay all collection costs that result from our collection efforts on delinquent balances, including reasonable attorney's fees.

#### LIABILITY

The publisher reserves the right to hold the advertiser and advertising agency jointly liable to SPIE for payments due hereunder. The advertiser is at all times liable for payment of all account balances due and all other liabilities and deemed to receive refund payments, adjustments, notices and all other documents when the same are delivered to their advertising agency. Payments by the advertiser to the advertising agency for services does not constitute payment to SPIE. Any language to the contrary in any advertising agency's insertion orders or other documents is void and without effect.

#### **BILLING AND DISCOUNTS**

- Billing and tear sheets will be mailed after the piece has been published. Payment must be made to SPIE within 30 days of invoice date. After 30 days, a 5% late fee will be added to all unpaid balances.
- Multiple ad placements per event receive a 10% discount for each additional ad.
- SPIE Corporate Members receive a 15% discount on published rates.